

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ZHENWEN LAI	08/16/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SHENZHEN JUFENGCAI ELECTRONIC TECHNOLOGY CO., LTD.
<b>Street Address:</b>	ROOM 1211, BUILDING 1, AREA B, RONGTAI PARK, SHAJING TOWN, BAOAN DISTRICT
<b>City:</b>	SHENZHEN, GUANGDONG
<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	29739783
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(918)515-4934
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	hdlsipr2@gmail.com
<b>Correspondent Name:</b>	STRATUM LAW LLC
<b>Address Line 1:</b>	P.O. BOX 1380
<b>Address Line 4:</b>	HAVERTOWN, PENNSYLVANIA 19083
<b>ATTORNEY DOCKET NUMBER:</b>	BYK-D-166
<b>NAME OF SUBMITTER:</b>	XIYAN ZHANG
<b>SIGNATURE:</b>	/Xiyang Zhang/
<b>DATE SIGNED:</b>	09/03/2021
This document serves as an Oath/Declaration (37 CFR 1.63).	
<b>Total Attachments: 1</b>	
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**ASSIGNMENT**

WHEREAS, Zhenwen LAI, residing at Shenzhen, is citizen of the China (hereafter the undersigned or assignor), is the inventor of

Monocular

[x] said application having been filed in the United States Patent and Trademark Office on 06/29/2020 , (Application Serial No. 29/739,783 ) the application serial number of said application when known;

AND, WHEREAS Shenzhen Jufengcai Electronic Technology Co., Ltd. ,

Who's address is Room 1211, Building 1, Area B, Rongtai Park, Shajing Town, Baoan District, Shenzhen, Guangdong, China hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefore, including any and all renewals, reissues and prolongations thereof;

NOW, THIS WITNESSETH, that for good and valuable consideration provided by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefore, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefore, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof,

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof,

To said assignee, and said assignee's successors and assigns, in accordance herewith.

Zhenwen LAI	/ Zhenwen LAI/	08/16/2021
_____ Name of Sole inventor	_____ Signature	_____ Date